

06-01-2000

Docket No.: 50090-214

05/22



To the Honorable Commissioner of Patents

101370316

I have attached original documents or copy thereto:

1. Name of Conveying Party(ies):

Tsutomu KOIKE

2. Name and address of receiving party(ies):

Name: Mitsubishi Denki Kabushiki Kaisha

Address: 2-3, Marunouchi 2-chome, Chiyoda-ku

Tokyo 100-8310, JAPAN

Additional name(s) of conveying party(ies) attached? ☐ Yes

3. Nature of Conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

Execution Date: May 9, 2000

Additional name(s) & address(es) attached? ☐ Yes

4. Application number(s) or patent number(s):

If the document is being filed together with a new application, the execution date of the application is: May 9, 2000

A. Patent Application No(s).

B. Patent No(s).

08/576437

Additional numbers attached? ☐ Yes

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: MCDERMOTT, WILL & EMERY

Internal Address:

Street Address: 600 13th Street, N.W.

City: Washington State: DC Zip: 20005

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41)

\$40.00

☐ Enclosed☒ Authorized to be charged to deposit account

8. Deposit account number:

500417

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05/30/2000 18215 00000074 500417 09576437

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Stephen A. Becker, 26,527

May 22, 2000

Name and Registration No. of Person Signing

Signature

Date

Total number of pages comprising cover sheet: 1

CMB No. 0851-0011 (exp. 4/94)

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272 072 14

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

Tsutomu KOIKE

who has made a certain new and useful invention, hereby sells, assigns and transfers unto

Mitsubishi Denki Kabushiki Kaisha
2-3, Marunouchi 2-chome
Chiyoda-ku, Tokyo 100-8310
JAPAN

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

METHOD OF ANALYZING FACTOR RESPONSIBLE FOR ERRORS IN WAFER PATTERN, AND
APPARATUS FOR PRODUCING PHOTOLITHOGRAPHIC MASK

for which an application for United States Letters Patent was executed on even date herewith,

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the international Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

INVENTOR

DATE SIGNED

Tsutomu Koike

May 9, 2000

Name: Tsutomu KOIKE